

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>TAKEHIKO SAWAI</td> <td>06/18/2012</td> </tr> <tr> <td>SHINJI SAITO</td> <td>06/18/2012</td> </tr> <tr> <td>KAZUNORI URAO</td> <td>06/18/2012</td> </tr> <tr> <td>TAKASHI KAWASAKI</td> <td>06/18/2012</td> </tr> </tbody> </table>		Name	Execution Date	TAKEHIKO SAWAI	06/18/2012	SHINJI SAITO	06/18/2012	KAZUNORI URAO	06/18/2012	TAKASHI KAWASAKI	06/18/2012		
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<table border="1"> <tr> <td>Name:</td> <td>DENKI KAGAKU KOGYO KABUSHIKI KAISHA</td> </tr> <tr> <td>Street Address:</td> <td>NIHONBASHI MITSUI TOWER, 1-1</td> </tr> <tr> <td>Internal Address:</td> <td>NIHONBASHI-MUROMACHI 2-CHOME, CHUO-KU</td> </tr> <tr> <td>City:</td> <td>TOKYO</td> </tr> <tr> <td>State/Country:</td> <td>JAPAN</td> </tr> <tr> <td>Postal Code:</td> <td>103-8338</td> </tr> </table>		Name:	DENKI KAGAKU KOGYO KABUSHIKI KAISHA	Street Address:	NIHONBASHI MITSUI TOWER, 1-1	Internal Address:	NIHONBASHI-MUROMACHI 2-CHOME, CHUO-KU	City:	TOKYO	State/Country:	JAPAN	Postal Code:	103-8338
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CORRESPONDENCE DATA													
Fax Number:	2123028998												
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ATTORNEY DOCKET NUMBER:	1007-091
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NAME OF SUBMITTER:	James V. Costigan
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Total Attachments: 2 source=1007P091assign#page1.tif source=1007P091assign#page2.tif
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A S S I G N M E N T

In consideration of One Dollar and other good and valuable consideration, of which we acknowledge receipt we, Takehiko SAWAI, Shinji SAITO, Kazunori URAO and Takashi KAWASAKI sell and assign to SEI Corporation, a corporation of Japan, residing at 862-2, Hisaishinmachi, Tsu-shi, Mie 514-1118 Japan, and DENKI KAGAKU KOGYO KABUSHIKI KAISHA, a corporation of Japan, residing at Nihonbashi Mitsui Tower, 1-1, Nihonbashi-Muromachi 2-chome, Chuo-ku, Tokyo 103-8338 Japan, its successors and assigns the entire right, title and interest in and to the improvements in ELECTRODE MATERIAL FOR LITHIUM SECONDARY BATTERY AND LITHIUM SECONDARY BATTERY invented by us, as described in the application for United States Letters Patent filed concurrently herewith, and all applications for patent and patents therefor in any and all countries, including all thereof, and all rights of priority resulting from the filing of said United States application, and authorize and request any official whose duty it is to issue patents, to issue any patent on said improvements or resulting therefrom to said SEI Corporation and DENKI KAGAKU KOGYO KABUSHIKI KAISHA, or its successors or assigns and agree that on request and without further consideration, but at the expense of said SEI Corporation and DENKI KAGAKU KOGYO KABUSHIKI KAISHA, we will communicate to said SEI Corporation and DENKI KAGAKU KOGYO KABUSHIKI KAISHA or its representatives or nominees any facts known to us respecting said improvements and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said SEI Corporation and DENKI KAGAKU KOGYO KABUSHIKI KAISHA, its successors, assigns, and nominees to obtain and enforce proper patent protection for said improvements in all countries.

June 18<sup>th</sup>, 2012

  
\_\_\_\_\_  
Takehiko SAWAI

June 18<sup>th</sup>, 2012

  
\_\_\_\_\_  
Shinji SAITO

Additional Inventors are being named on the supplemental sheet attached hereto.

(Additional Inventor(s) supplemental sheet)

June 18, 2012

Kazunori URAO  
Kazunori URAO

June 25th, 2012

Takashi Kawasaki  
Takashi KAWASAKI